

## News Release

**Contact:**

**Siliconware Precision Industries Co., Ltd.**  
No.45, Jieh Show Rd.  
Hsinchu Science Park, Hsinchu  
Taiwan, 30056  
[www.spil.com.tw](http://www.spil.com.tw)

Janet Chen, IR Director  
[janet@spil.com.tw](mailto:janet@spil.com.tw)  
+886-3-5795678#3675  
Byron Chiang, Spokesperson  
[byronc@spil.com.tw](mailto:byronc@spil.com.tw)  
+886-3-5795678#3671

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### 矽品與南茂集團簽署機器設備買賣契約及股票買賣契約

發佈單位：矽品精密工業股份有限公司

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矽品精密工業股份有限公司（台灣證券交易所代號：2325，NASDAQ：SPIL，以下簡稱本公司）董事會通過出售機器設備一批與南茂科技股份有限公司（以下簡稱「南茂科技」），交易總金額為新台幣 1,630,580 仟元，雙方並將簽署機器設備買賣契約。依契約約定，南茂科技將在 2011 年 3 月底前分四次支付價款，且本公司承諾於簽約後五年內，不另建置 DRAM 測試及 LCD 驅動 IC 封測產能。本交易處分利益估約新台幣 52,636 仟元，因採分次移交，實際金額以移交時為準。

本公司董事會同時通過向 ChipMOS TECHNOLOGIES (Bermuda) LTD. (百慕達商南茂科技股份有限公司，NASDAQ 股票代號 IMOS，以下簡稱「百慕達南茂」) 取得其 100% 子公司-南茂科技普通股 133,000 仟股，交易總金額為新台幣 1,630,580 仟元，佔南茂科技股權約 15.8%，雙方並將簽署股票買賣契約。依契約約定，本公司將在 2011 年 3 月底前分四次支付價款。

## **About SPIL**

Siliconware Precision Industries Ltd. ("SPIL")(NASDAQ: SPIL, Taiwan Stock Exchange: 2325) is a leading provider of comprehensive semiconductor assembly and test services. SPIL is dedicated to meeting all of its customers' integrated circuit packaging and testing requirements, with turnkey solutions that range from design consultations, modeling and simulations, wafer bumping, wafer probe and sort, package assembly, final test, burn-in, to drop ship. Products include advanced leadframe and substrate packages, which are widely used in personal computers, communications, Internet appliances, cellular phones, digital cameras, cable modems, personal digital assistants and LCD monitors. SPIL supplies services and support to fabless design houses, integrated device manufacturers and wafer foundries globally. For further information, visit SPIL's web site at [www.spil.com.tw](http://www.spil.com.tw).

## **Safe Harbor Statement**

The information herein contains forward-looking statements within the meaning of Section 27A of the U.S. Securities Act of 1933 and Section 21E of the U.S. Securities Exchange Act of 1934. We have based these forward-looking statements on our current expectation and projections about future events. Such forward-looking statements are inherently subject to known and unknown risks, uncertainties, assumptions about us and other factors that may cause the actual performance, financial condition or results of operations of SPIL to be materially different from what may be implied by such forward-looking statements. Investors are cautioned that actual events and results could differ materially from those statements as a result of a number of factors, including, among other things:

- the intensely competitive personal computer, communications, consumer ICs and non-commodity memory semiconductor industries and markets;
- cyclical nature of the semiconductor industry;
- risks associated with global business activities;
- non-operating losses due to poor financial performance of some of our investments;
- our dependence on key personnel;
- general economic and political conditions;
- possible disruptions in commercial activities caused by natural and human induced disaster, including terrorist activities and armed conflicts and contagious disease, such as the Severe Acute Respiratory Syndrome;
- fluctuations in foreign currency exchange rates; and
- other risks identified in our annual reports on Form 20-F filed with the U.S. Securities and Exchange Commission each year.

The words "anticipate," "believe," "estimate," "expect," "intend," "plan" and similar expressions, as they relate to us, are intended to identify a number of these forward-looking statements. We undertake no obligation to update or revise any forward-looking statements whether as a result of new information, future events or otherwise. In light of these risks, uncertainties and assumptions, the forward-looking events discussed herein might not occur and our actual results could differ materially from those anticipated in these forward-looking statements.